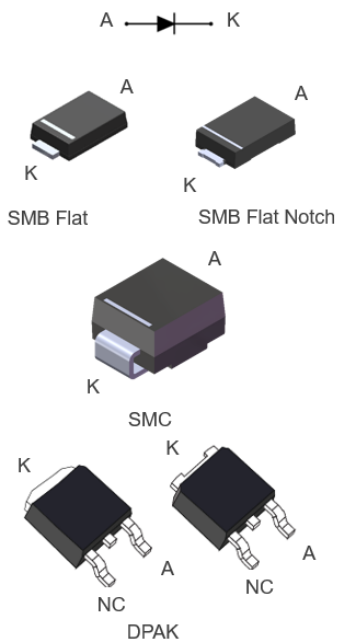


## 4 A - 200 V power Schottky rectifier



### Features

- Negligible switching losses
- High junction temperature capability
- Very small conduction losses
- Low leakage current
- $T_j = -40\text{ °C}$  minimum operating
- **ECOPACK2** component

### Applications

- Inverter
- Lighting
- Battery charger
- Telecom power
- Home appliance

### Description

Single chip Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SMB Flat Notch, SMB Flat, SMC and DPAK, the **STPS4S200** is ideal for surface mounting and used in low voltage, high frequency inverters, free wheeling and polarity protection applications.

Product status	
STPS4S200	
Product summary	
Symbol	Value
$I_{F(AV)}$	4 A
$V_{RRM}$	200 V
$T_{j(max.)}$	175 °C
$V_{F(typ.)}$	0.64 V

# 1 Characteristics

**Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)**

Symbol	Parameter		Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage		200	V	
$I_{F(RMS)}$	Forward rms current		10	A	
$I_{F(AV)}$	Average forward current, $\delta = 0.5$ , square wave	SMB Flat Notch, SMC, SMB Flat	$T_L = 125\text{ °C}$	4	A
		DPAK	$T_c = 160\text{ °C}$		
$I_{FSM}$	Surge non repetitive forward current		$t_p = 10\text{ ms sinusoidal}$	130	A
$T_{stg}$	Storage temperature range		-65 to +175		°C
$T_j$	Operating junction temperature range <sup>(1)</sup>		-40 to +175		°C

1.  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

**Table 2. Thermal resistance parameter**

Symbol	Parameter	Max. value	Unit
$R_{th(j-l)}$	Junction to lead (SMB Flat Notch, SMC, SMB Flat)	15	°C/W
$R_{th(j-c)}$	Junction to case	3.2	

For more information, please refer to the following application note :

- AN5088 : Rectifiers thermal management, handling and mounting recommendations

**Table 3. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-		5	μA
		$T_j = 125\text{ °C}$		-	0.70	2.50	mA
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 4\text{ A}$	-		0.87	V
		$T_j = 125\text{ °C}$		-	0.64	0.71	

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

2. Pulse test:  $t_p = 380\text{ μs}$ ,  $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

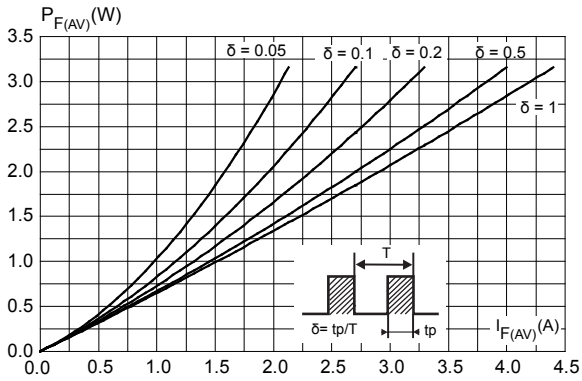
$$P = 0.63 \times I_{F(AV)} + 0.020 \times I_{F(RMS)}^2$$

For more information, please refer to the following application notes related to the power losses :

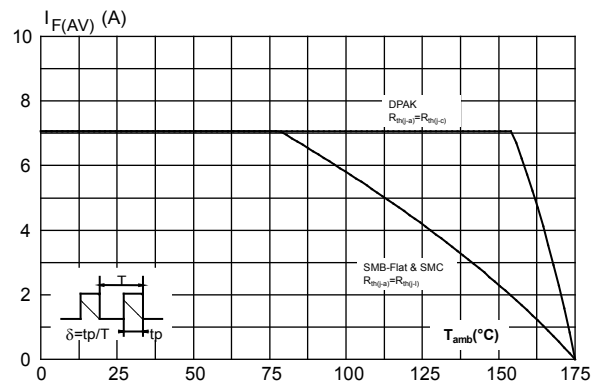
- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

## 1.1 Characteristics (curves)

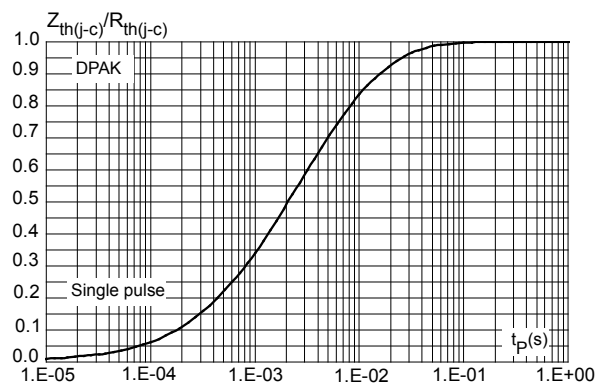
**Figure 1. Average forward power dissipation versus average forward current**



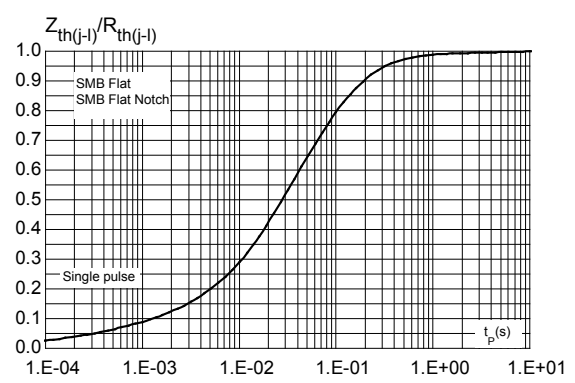
**Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ )**



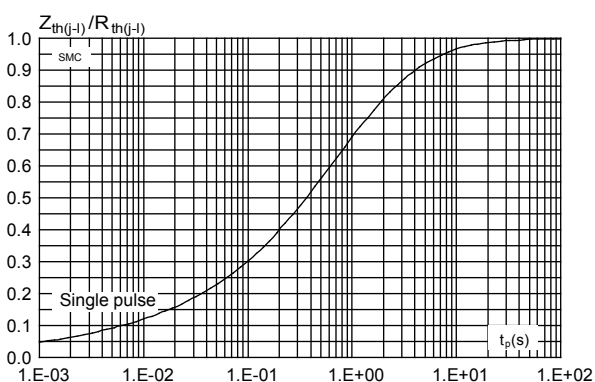
**Figure 3. Relative variation of thermal impedance junction to case versus pulse duration (DPAK)**



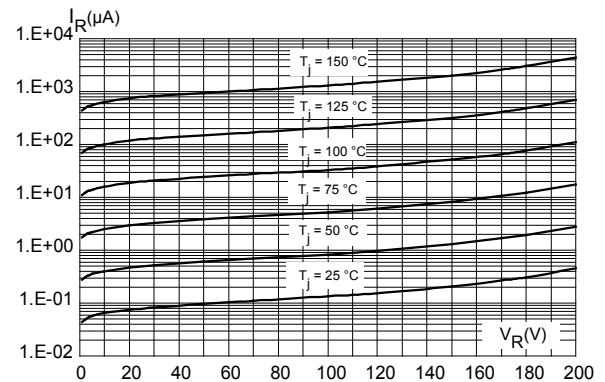
**Figure 4. Relative variation of thermal impedance junction to lead versus pulse duration (SMB flat, SMB flat Notch)**



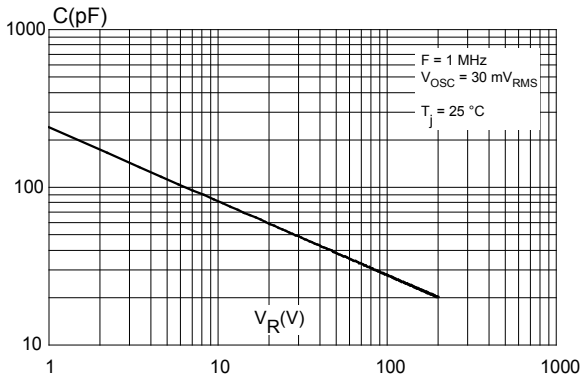
**Figure 5. Relative variation of thermal impedance junction to lead versus pulse duration (SMC)**



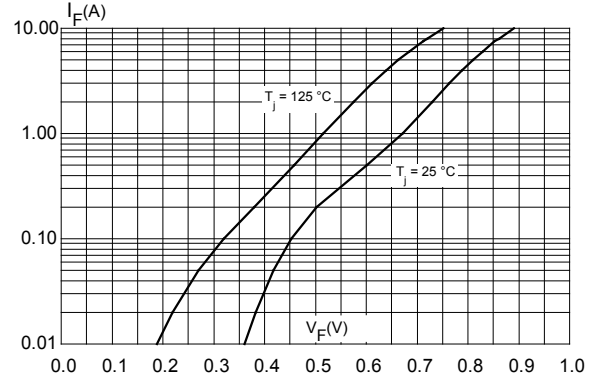
**Figure 6. Reverse leakage current versus reverse voltage applied (typical values)**



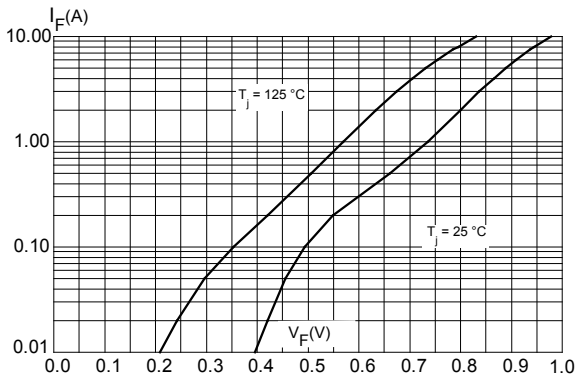
**Figure 7. Junction capacitance versus reverse voltage applied (typical values)**



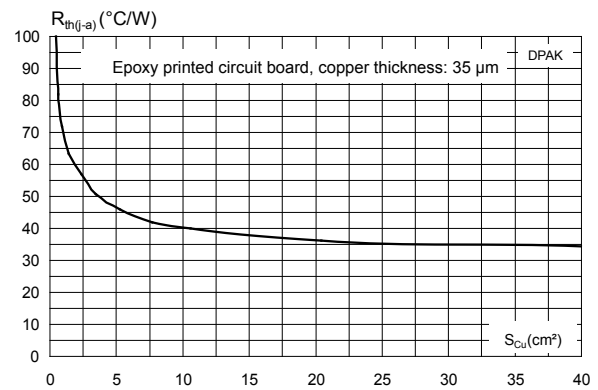
**Figure 8. Forward voltage drop versus forward current (typical values)**



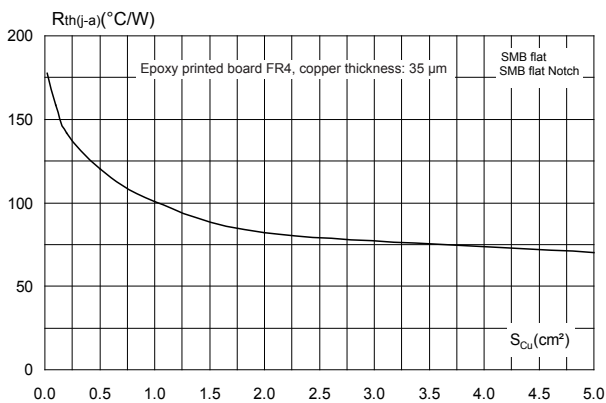
**Figure 9. Forward voltage drop versus forward current (maximum values)**



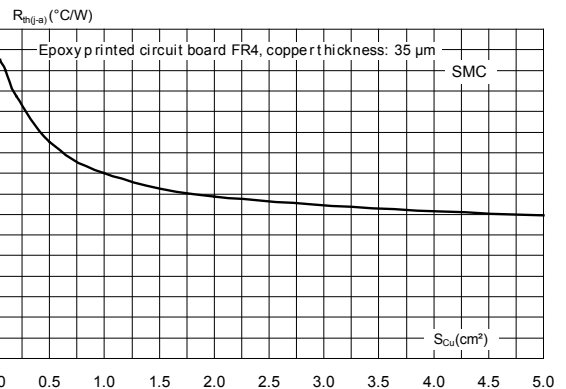
**Figure 10. Thermal resistance junction to ambient versus copper surface under tab (DPAK)**



**Figure 11. Thermal resistance junction to ambient versus copper surface under each lead (SMB Flat, SMB Flat Notch)**



**Figure 12. Thermal resistance junction to ambient versus copper surface under each lead (SMC)**



## 2 Package information

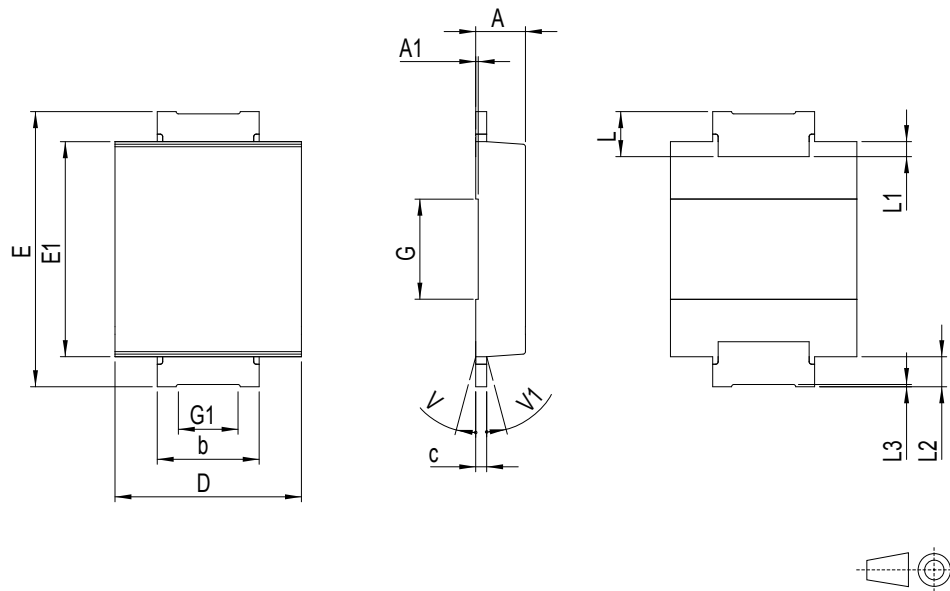
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In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

## 2.1 SMB Flat Notch package information

- Epoxy meets UL94, V0
- Lead-free package

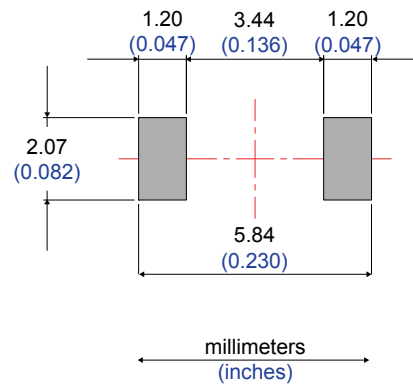
**Figure 13. SMB Flat Notch package outline**



**Table 4. SMB Flat Notch mechanical data**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
A1		0.05			0.002	
b	1.95		2.20	0.077		0.087
c	0.15		0.40	0.006		0.016
D	3.30		3.95	0.130		0.156
E	5.20		5.60	0.205		0.220
E1	4.05		4.60	0.159		0.181
G		2.00			0.079	
G1		1.20			0.047	
L	0.75		1.20	0.030		0.047
L1		0.30			0.012	
L2		0.60			0.024	
L3	0.02			0.001		
V			8°			8°
V1			8°			8°

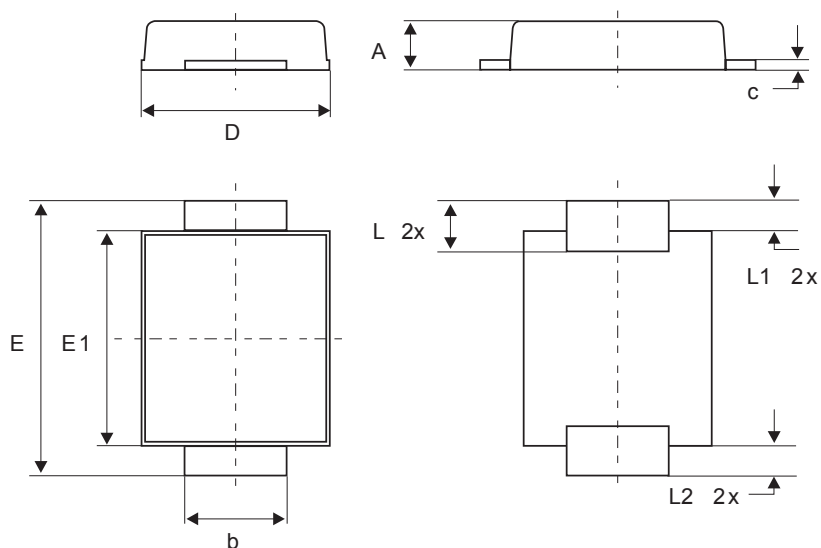
**Figure 14. Footprint recommendations, dimensions in mm (inches)**



## 2.2 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

**Figure 15. SMB Flat package outline**

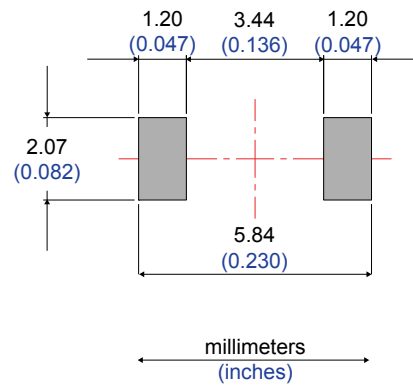


**Table 5. SMB Flat mechanical data**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.044
b	1.95		2.20	0.076		0.087
c	0.15		0.40	0.005		0.016
D	3.30		3.95	0.129		0.156
E	5.10		5.60	0.200		0.221
E1	4.05		4.60	0.159		0.182
L	0.75		1.50	0.029		0.060
L1		0.40			0.016	
L2		0.60			0.024	



**Figure 16. Footprint recommendations, dimensions in mm (inches)**



### 2.3 SMC package information

- Epoxy meets UL94, V0

Figure 17. SMC package outline

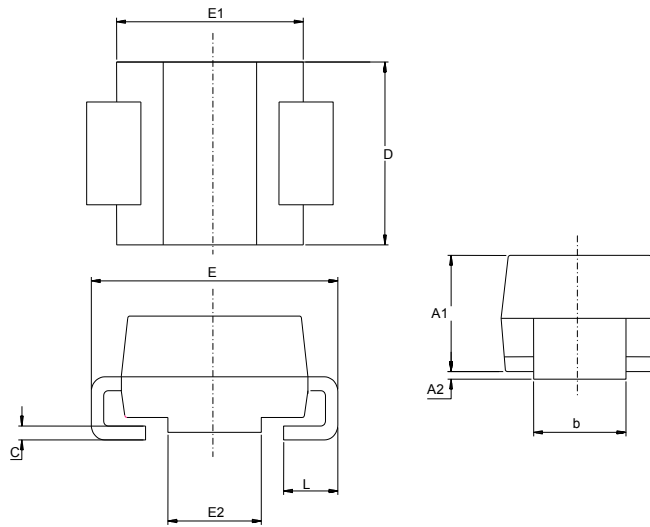
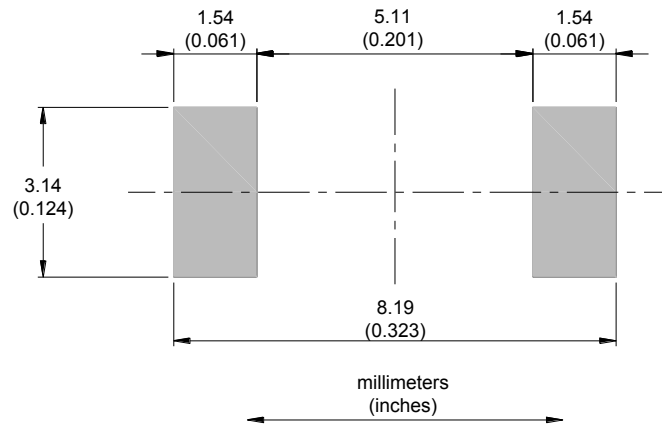


Table 6. SMC package mechanical data

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.0748	0.0965
A2	0.05	0.20	0.0020	0.0079
b	2.90	3.20	0.1142	0.1260
c	0.15	0.40	0.0059	0.0157
D	5.55	6.25	0.2185	0.2461
E	7.75	8.15	0.3051	0.3209
E1	6.60	7.15	0.2598	0.2815
E2	4.40	4.70	0.1732	0.1850
L	0.75	1.50	0.0295	0.0591

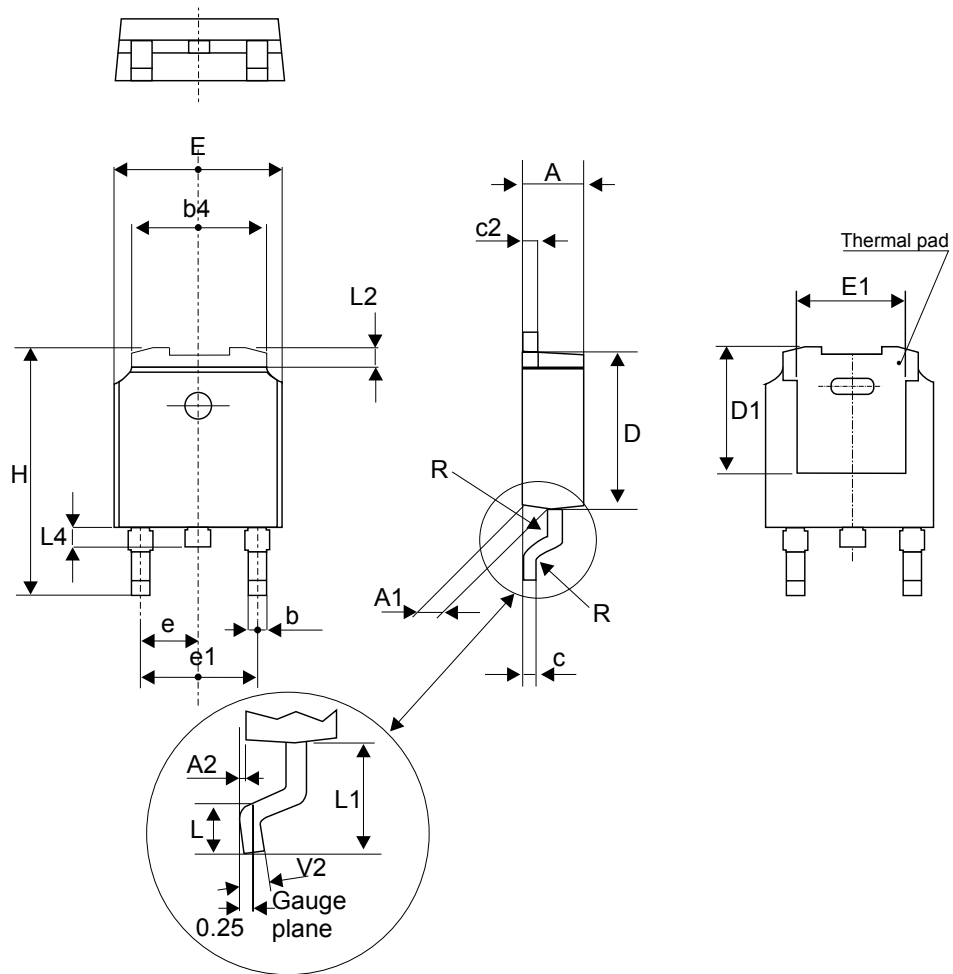
**Figure 18. SMC recommended footprint**



## 2.4 DPAK package information

- Epoxy meets UL 94, V0
- Cooling method: by conduction (C)

Figure 19. DPAK package outline

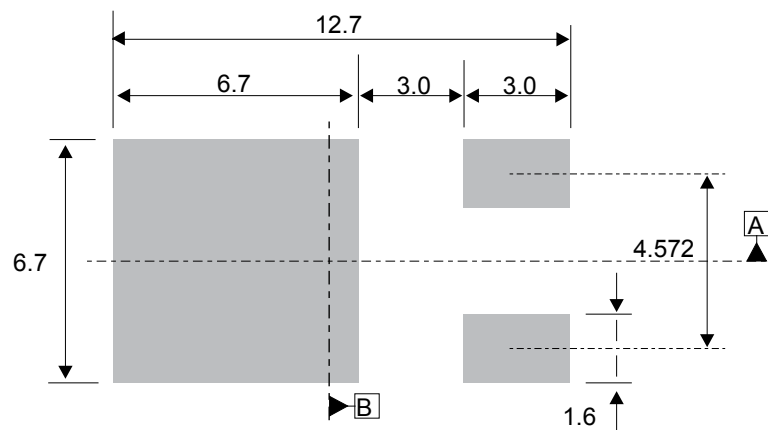


*Note:* This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

**Table 7. DPAK package mechanical data**

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A	2.18	2.40	0.085	0.094
A1	0.90	1.10	0.035	0.043
A2	0.03	0.23	0.001	0.009
b	0.64	0.90	0.025	0.035
b4	4.95	5.46	0.194	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.60	0.018	0.023
D	5.97	6.22	0.235	0.244
D1	4.95	5.60	0.194	0.220
E	6.35	6.73	0.250	0.265
E1	4.32	5.50	0.170	0.216
e	2.286 typ.		0.090 typ.	
e1	4.40	4.70	0.173	0.185
H	9.35	10.40	0.368	0.409
L	1.0	1.78	0.039	0.070
L2		1.27		0.050
L4	0.60	1.02	0.023	0.040
V2	-8°	+8°	-8°	+8°

**Figure 20. DPAK recommended footprint (dimensions in mm)**



The device must be positioned within  $\oplus 0.05$  AB

### 3 Ordering information

**Table 8. Ordering information**

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS4S200B-TR	S4 200B	D <sup>2</sup> PAK	0.032 g	10 000	Tape and reel
STPS4S200S	S42	SMC	0.250 g	2500	Tape and reel
STPS4S200UF	FG42	SMB Flat	0.050 g	5000	Tape and reel
STPS4S200UFN	B42	SMB Flat Notch	0.056 g	5000	Tape and reel

## Revision history

**Table 9. Document revision history**

Date	Version	Changes
17-Oct-2014	1	First release.
26-Aug-2015	2	Added device in SMC package. Updated document accordingly.
15-May-2017	3	Updated DPAK package information and reformatted to current standard.
31-Jan-2019	4	Added <a href="#">Section 2.1 SMB Flat Notch package information</a> .
01-Jun-2021	5	Removed normalized avalanche curve.

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